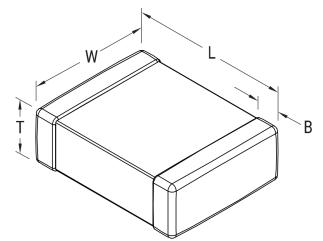


C1206X474K3REC7210

ESD SMD Comm X7R, Ceramic, 0.47 uF, 10%, 25 VDC, X7R, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II, 1206



Click here for the 3D model.

Dimensions		
Chip Size	1206	
L	3.3mm +/-0.4mm	
W	1.6mm +/-0.35mm	
Т	1.6mm +/-0.25mm	
В	0.6mm +/-0.25mm	

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	8000

General Information	
Series	ESD SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Component Weight	55 mg
Shelf Life	78 Weeks
MSL	1

Specifications				
Capacitance	0.47 uF			
Measurement Condition	1 kHz 1.0Vrms			
Capacitance Tolerance	10%			
Voltage DC	25 VDC			
ESD Level per AEC-Q200	25,000 V ESD Level			
Dielectric Withstanding Voltage	62.5 VDC			
Temperature Range	-55/+125°C			
Temperature Coefficient	X7R			
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms			
Dissipation Factor	3.5%1 kHz 1.0Vrms			
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours			
Insulation Resistance	1.0638 GOhms			

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